

STS5DNF20V

N-channel 20 V, 0.030 Ω typ, 5 A STripFET™ II Power MOSFET in a SO-8 package

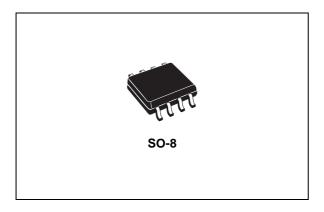
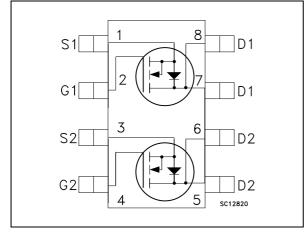


Figure 1. Internal schematic diagram



Datasheet - production data

Features

Order code	V_{DSS}	R _{DS(on)} max.	I _D
STS5DNF20V	20 V	0.040 Ω @ 4.5 V	5 A
5155DN120V	20 V	0.045 Ω @ 2.7 V	37

- Ultra low threshold gate drive (2.7 V)
- Standard outline for easy automated surface mount assembly

Applications

• Switching application

Description

This Power MOSFET has been developed using STMicroelectronics' unique STripFET process, which is specifically designed to minimize input capacitance and gate charge. This renders the device suitable for use as primary switch in advanced high-efficiency isolated DC-DC converters for telecom and computer applications, and applications with low gate charge driving requirements.

Table 1. Device summary

Order code	Marking	Package	Packaging
STS5DNF20V	5DF20V	SO-8	Tape and reel

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1 Electrical ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	20	V
V _{GS}	Gate-source voltage	±12	V
Ι _D	Drain current (continuous) at T _C = 25 °C	5	А
Ι _D	Drain current (continuous) at T _C = 100 °C	3	А
I _{DM} ⁽¹⁾	Drain current (pulsed)	20	А
P _{TOT}	Total dissipation at $T_{C} = 25 \text{ °C}$ (dual operation)	1.6	W
P _{TOT}	Total dissipation at $T_{C} = 25 \text{ °C}$ (single operation)	2	W
ТJ	Max. operating junction temperature	-55 to 150	℃
T _{stg}	Storage temperature	-55 10 150	C

Table 2. Absolute maximum ratings

1. Pulse width limited by safe operating area.

Table 3. Thermal data

Symbol Parameter		Value	Unit
Б	Thermal resistance junction-ambient single operation	62.5	°C/W
R _{thj-a}	Thermal resistance junction-ambient dual operation	78	°C/W



2 Electrical characteristics

		e 4. On/on states				
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0$	20			V
1	Zero gate voltage	V _{DS} = 20			1	μA
I _{DSS}	Drain current (V _{GS} = 0)	V_{DS} = 20 V, T_{C} =125 °C			10	μA
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 12 V			±100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS}=V_{GS},I_{D}=250\;\mu\text{A}$	0.6			Ω
P	Static drain-source	V_{GS} = 4.5 V, I _D = 2.5 A		0.030	0.040	Ω
R _{DS(on)}	on- resistance	V_{GS} = 2.7 V, I _D = 2.5 A		0.037	0.045	Ω

Table 4. On/off states

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	460		pF
C _{oss}	Output capacitance	V _{DS} = 25 V, f = 1 MHz, V _{GS} = 0	-	200		pF
C _{rss}	Reverse transfer capacitance		-	50		pF
Qg	Total gate charge	V _{DD} = 16 V, I _D = 5 A,	-	8.5	11.5	nC
Q _{gs}	Gate-source charge	V _{GS} = 4.5 V	-	1.8		nC
Q _{gd}	Gate-drain charge	(see Figure 13)	-	2.4		nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time		-	7	-	ns
t _r	Rise time	V _{DD} =10 V, I _D =2.5A, R _G =4.7Ω, V _{GS} = 4.5V	-	33	-	ns
t _{d(off)}	Turn-off delay time	(see <i>Figure 12</i>)	-	27	-	ns
t _f	Fall Time		-	10	-	ns



Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
I _{SD}	Source-drain current		-		5	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		20	А
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 5 A, V _{GS} = 0	-		1.2	V
t _{rr}	Reverse recovery time	$I_{SD} = 5 \text{ A}, V_{DD} = 10 \text{ V},$	-	26		ns
Q _{rr}	Reverse recovery charge	di/dt = 100 A/µs, T _i = 150 °C	-	13		nC
I _{RRM}	Reverse recovery current	(see <i>Figure 14</i>)	-	1		А

Table 7. Source drain diode

1. Pulse width limited by safe operating area.

2. Pulsed: pulse duration = $300 \ \mu$ s, duty cycle 1.5%



 $\frac{GC83240}{Z_{th} = k R_{thJ-c}}$

 $\delta = t_p / \tau$

2.1 Electrical characteristics (curves)

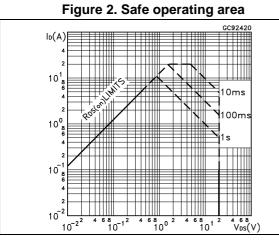


Figure 4. Output characteristics

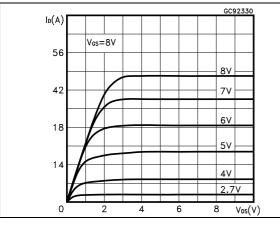


Figure 6. Source-drain diode forward characteristics

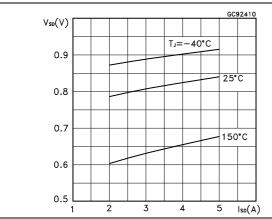


Figure 3. Thermal impedance

Κ

Figure 5. Transfer characteristics

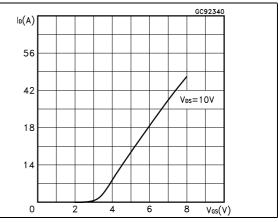


Figure 7. Static drain-source on resistance

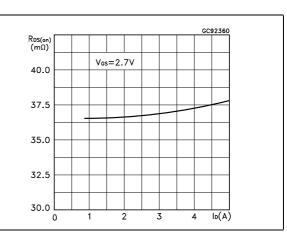




Figure 8. Gate charge vs gate-source voltage

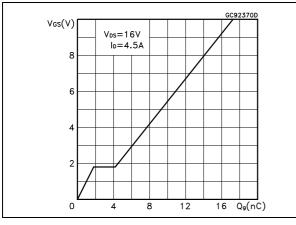


Figure 10. Normalized gate threshold voltage vs temperature

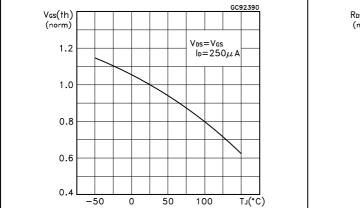
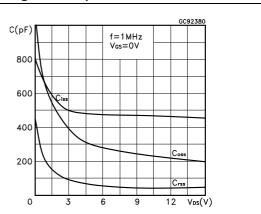
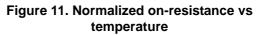
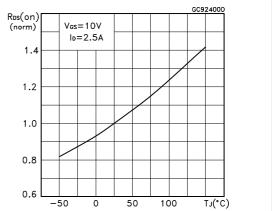


Figure 9. Capacitance variations







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3 **Test circuit**

Figure 12. Switching times test circuit for resistive load

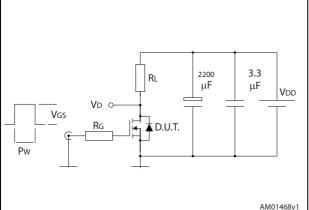


Figure 14. Test circuit for inductive load switching and diode recovery times

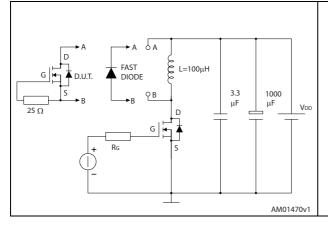


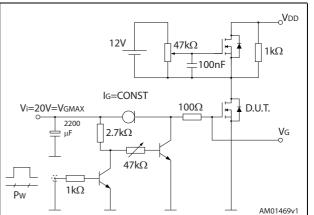
Figure 16. Unclamped inductive waveform

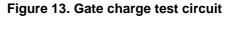
VD

IDM

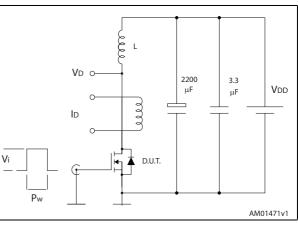
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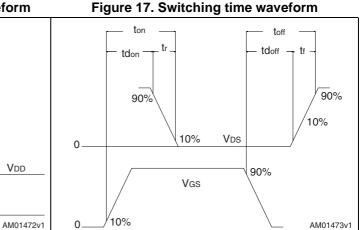
V(BR)DSS













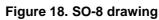
Vdd

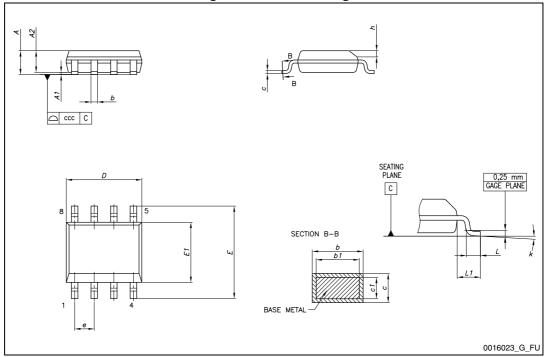
Vdd

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.









		mm	
Dim. —	Min.	Тур.	Max.
А			1.75
A1	0.10		0.25
A2	1.25		
b	0.31		0.51
b1	0.28		0.48
С	0.10		0.25
c1	0.10		0.23
D	4.80	4.90	5.00
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
е		1.27	
h	0.25		0.50
L	0.40		1.27
L1		1.04	
L2		0.25	
k	0°		8°
ccc			0.10

Table 8. SO-8 mechanical data



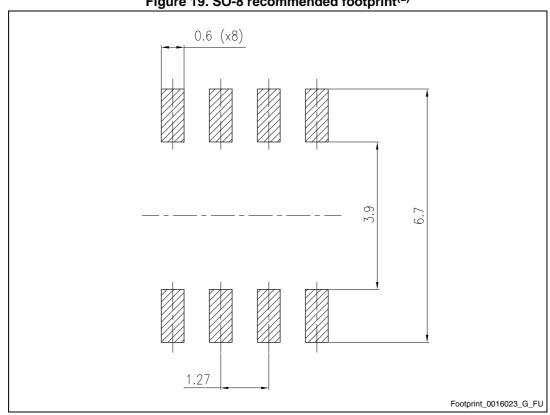


Figure 19. SO-8 recommended footprint^(a)

a. All dimensions are in millimeters.



5 Revision history

Date	Revision	Changes
21-Jun-2004	4	Complete document
13-Nov-2006	5	The document has been reformatted
02-May-2011	6	Table 1: Device summary has been corrected
06-Mar-2014	7	Modified: Marking in <i>Table 1</i> Updated: Section 4: Package mechanical data, Figure 12: Switching times test circuit for resistive load, Figure 13: Gate charge test circuit, Figure 14: Test circuit for inductive load switching and diode recovery times and Figure 15: Unclamped Inductive load test circuit. Minor text changes.



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